SiHH20N50E

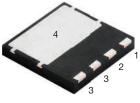
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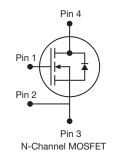


E Series Power MOSFET

PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	550			
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	0.147		
Q _g max. (nC)	70			
Q _{gs} (nC)	9			
Q _{gd} (nC)	15			
Configuration	Single			

PowerPAK[®] 8 x 8





FEATURES

- · Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- · Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

APPLICATIONS

- · Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and Halogen-free	SiHH20N50E-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-Source Voltage		V _{DS}	500	V		
Gate-Source Voltage		V _{GS}	± 30	v		
Continuous Drain Current (T _J = 150 °C)	$V_{GS} \text{ at 10 V} \frac{T_C = 25 \text{ °C}}{T_C = 100 \text{ °C}}$	Ι _D	22			
	$T_{\rm C} = 100 ^{\circ}{\rm C}$		14	А		
Pulsed Drain Current ^a	I _{DM}	53				
Linear Derating Factor			1.4	W/°C		
Single Pulse Avalanche Energy ^b		E _{AS}	286	mJ		
Maximum Power Dissipation		PD	174	W		
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	T _J = 125 °C	dV/dt	70	V/ns		
Reverse Diode dV/dt ^c		uv/di	19	v/ns		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 4.5 A.

c. $I_{SD} \leq I_D$, dI/dt = 100 A/µs, starting T_J = 25 °C.

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COMPLIANT

HALOGEN FREE

www.vishay.com

SiHH20N50E

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THERMAL RESISTANCE RATI	NGS							
PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	40		52				
Maximum Junction-to-Case (Drain)	R _{thJC}	0.55 0.72			- °C/W			
		•						
SPECIFICATIONS (T _J = 25 °C, u	nless otherwi	se noted)						
PARAMETER	SYMBOL	1		IONS	MIN.	TYP.	MAX.	UNIT
Static		1				1		1
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	0 V, I _D = 2	250 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 1 mA	-	0.56	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	V_{GS} , $I_D = 2$	250 µA	2.0	-	4.0	V
		١	$V_{GS} = \pm 20 V$ $V_{GS} = \pm 30 V$		-	-	± 100	nA
Gate-Source Leakage	I _{GSS}	N			-	-	± 1	μA
		V _{DS} =	500 V, V _{GS}	_S = 0 V	-	-	1	μΑ
Zero Gate Voltage Drain Current	IDSS	V _{DS} = 400 V	, V _{GS} = 0 V	, Т _Ј = 125 °С	-	-	25	
Drain-Source On-State Resistance	R _{DS(on)}	$V_{GS} = 10 V$	۱ _D	₀ = 10 A	-	0.128	0.147	Ω
Forward Transconductance	9 _{fs}	V _{DS} =	= 30 V, I _D =	: 10 A	-	8.4	-	S
Dynamic					•	•		
Input Capacitance	C _{iss}		$V_{GS} = 0 V,$		-	2063	-	
Output Capacitance	C _{oss}	$V_{DS} = 100 V,$ f = 1 MHz		-	108	-	pF	
Reverse Transfer Capacitance	C _{rss}			-	7	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		-	91	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	282	-		
Total Gate Charge	Qg				-	56	84	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	V _{GS} = 10 V I _D = 10 A, V _{DS}		- 12	-	nC	
Gate-Drain Charge	Q _{gd}				-	23	-	
Turn-On Delay Time	t _{d(on)}				-	22	44	
Rise Time	t _r	V _{DD} = 400 V, I _D = 10 A,		= 10 A,	-	41	82	- ns
Turn-Off Delay Time	t _{d(off)}	V _{GS} =	$V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	67	101	
Fall Time	t _f				-	41	82	
Gate Input Resistance	R _g	f = 1 MHz		0.3	0.6	1.2	Ω	
Drain-Source Body Diode Characteristic	s							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	22	A	
Pulsed Diode Forward Current	I _{SM}			-	-	53		
Diode Forward Voltage	V _{SD}	T _J = 25 °C	c, I _S = 10 A	, V _{GS} = 0 V	-	0.9	1.2	V
Reverse Recovery Time	t _{rr}	$T_J = 25 \text{ °C}, I_F = I_S = 10 \text{ A},$ dl/dt = 100 A/µs, V _R = 25 V		-	271	542	ns	
Reverse Recovery Charge	Q _{rr}			-	3.5	7.0	μC	
Reverse Recovery Current	I _{RRM}			-	24	-	А	

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS} .

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDS.

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SiHH20N50E

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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

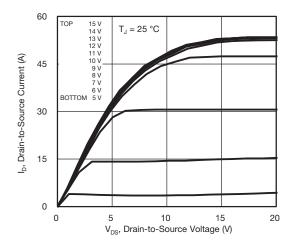
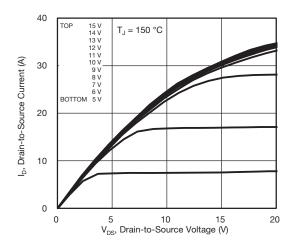
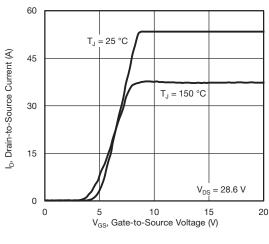


Fig. 1 - Typical Output Characteristics









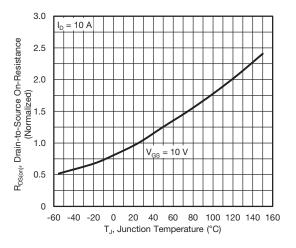


Fig. 4 - Normalized On-Resistance vs. Temperature

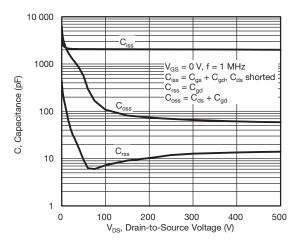


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

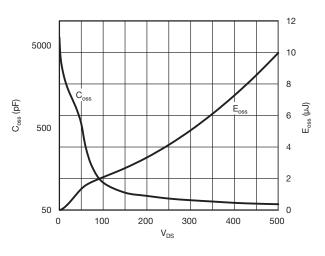


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}

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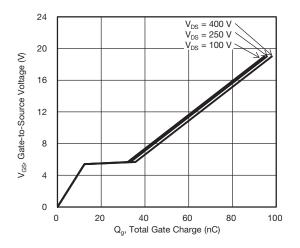


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

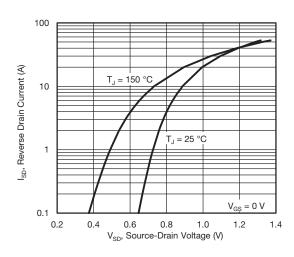


Fig. 8 - Typical Source-Drain Diode Forward Voltage

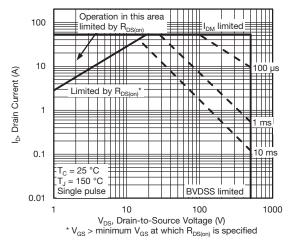


Fig. 9 - Maximum Safe Operating Area

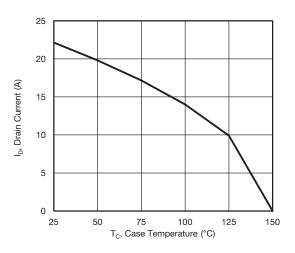


Fig. 10 - Maximum Drain Current vs. Case Temperature

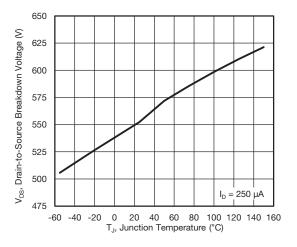
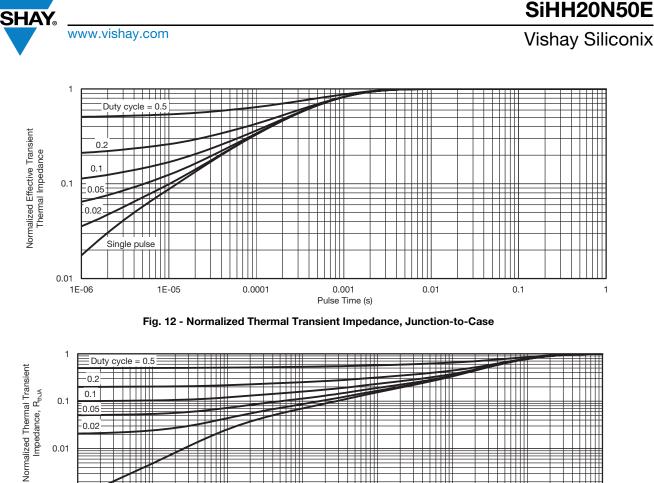


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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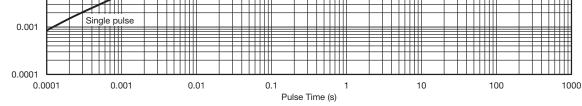


Fig. 13 - Normalized Thermal Transient Impedance, Junction-to-Ambient

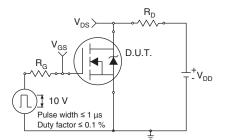


Fig. 14 - Switching Time Test Circuit

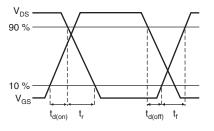


Fig. 15 - Switching Time Waveforms

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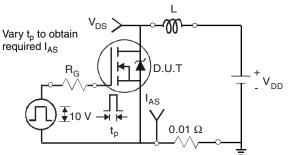
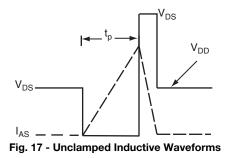


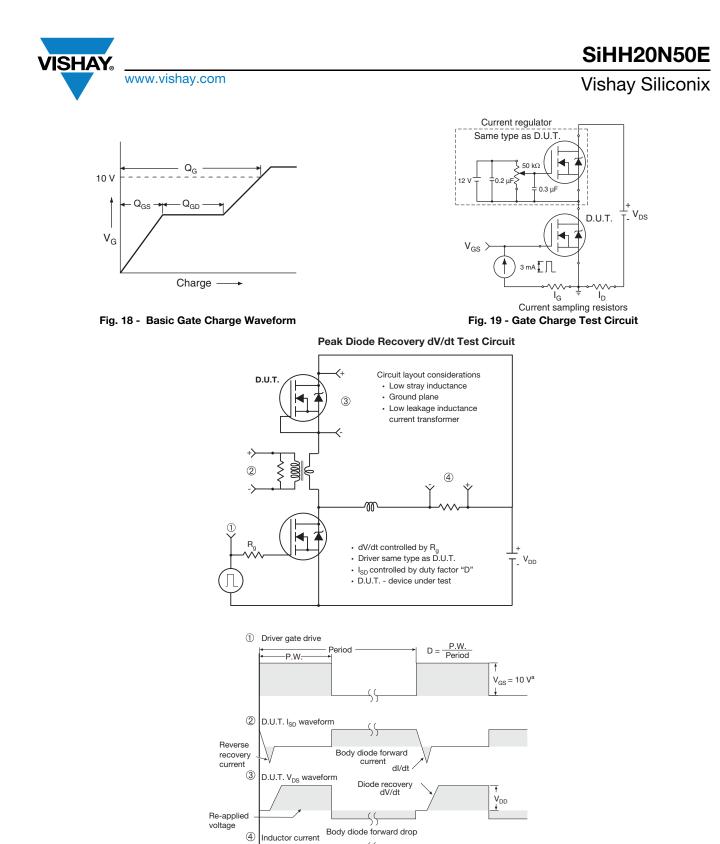
Fig. 16 - Unclamped Inductive Test Circuit



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Ripple ≤ 5 %

Fig. 20 - For N-Channel

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a. $V_{GS} = 5 V$ for logic level devices

Note

 I_{SD}

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